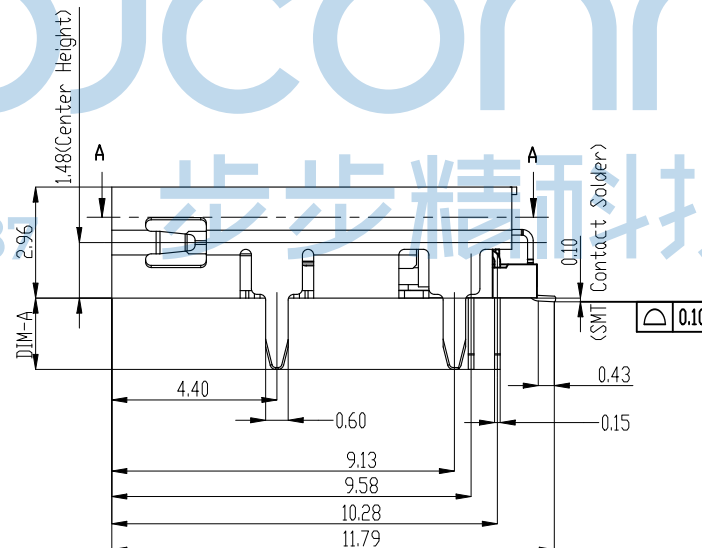
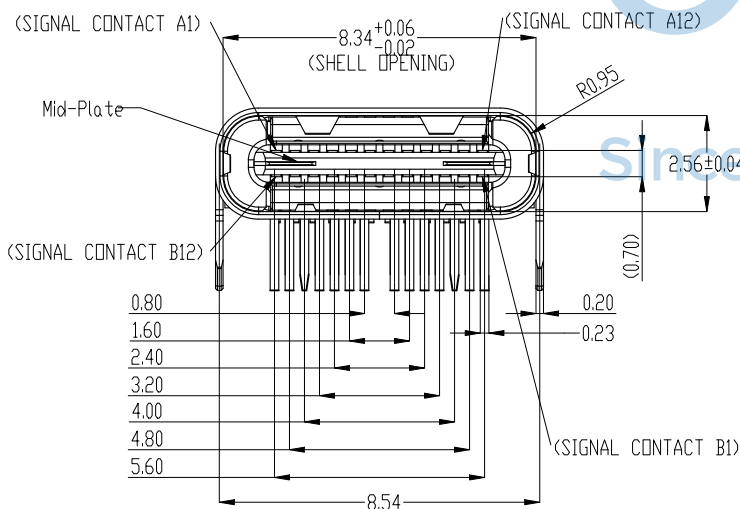
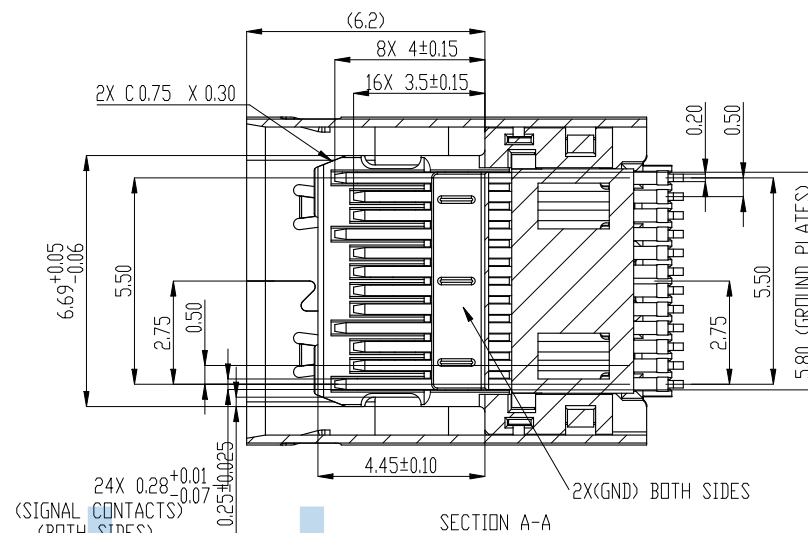
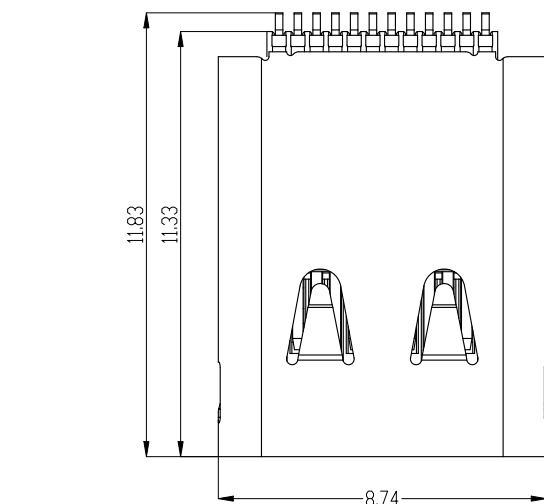


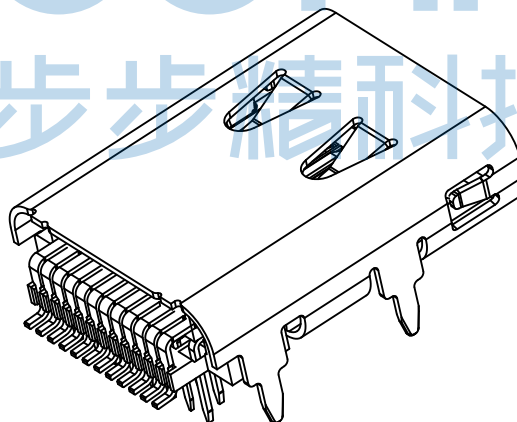
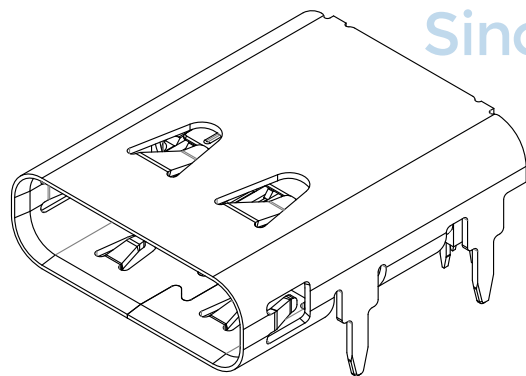
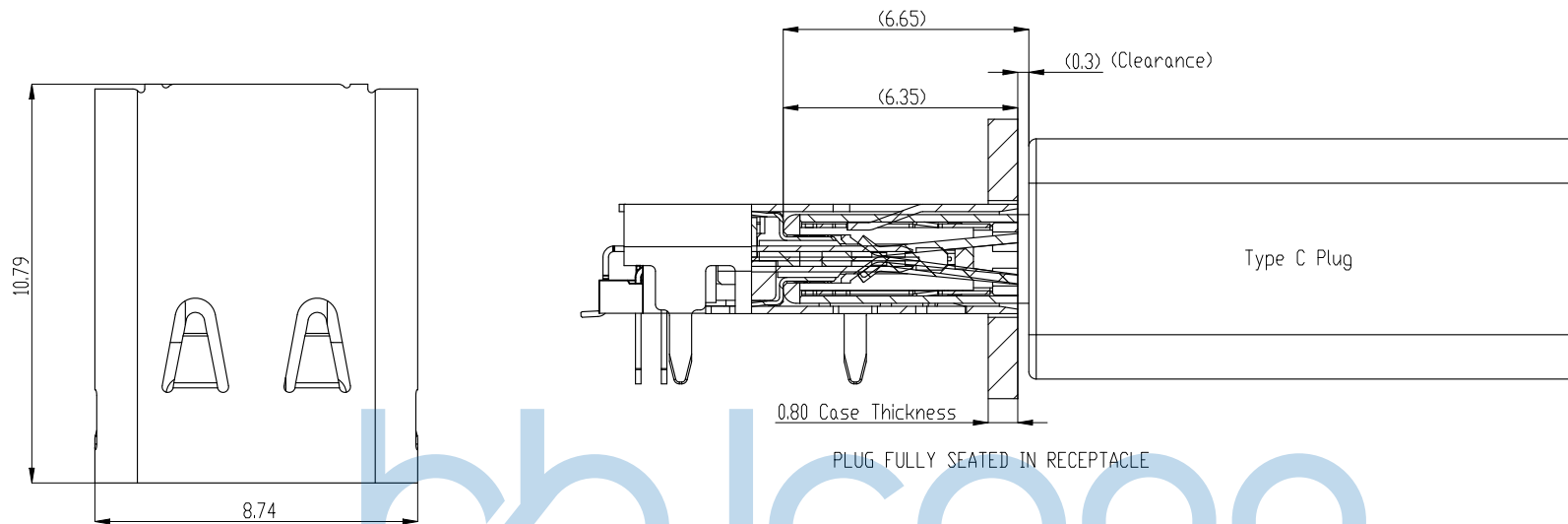
REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

SPECIFICATION
MATERIAL
 Insulator: Thermoplastic, LCP Black
 Contacts: BRASS C2680
 Shell: Stainless Steel SUS304
CONTACT PLATING
 Underplate: 40u"~80u" Nickel
 Contact area: Au1u"
 Solder tails area: 100u"~200u" Tin (Lead Free)
ELECTRICAL
 Operation voltage: 20 V
 Current rating: 5 Amps max.
 Insulation resistance: 100 Mohms min @ 100 VDC
 Dielectric withstanding voltage: 100 VAC / minute
 Temperature range: -40° C TO +105° C
 Mating cycles: 10,000 insertions

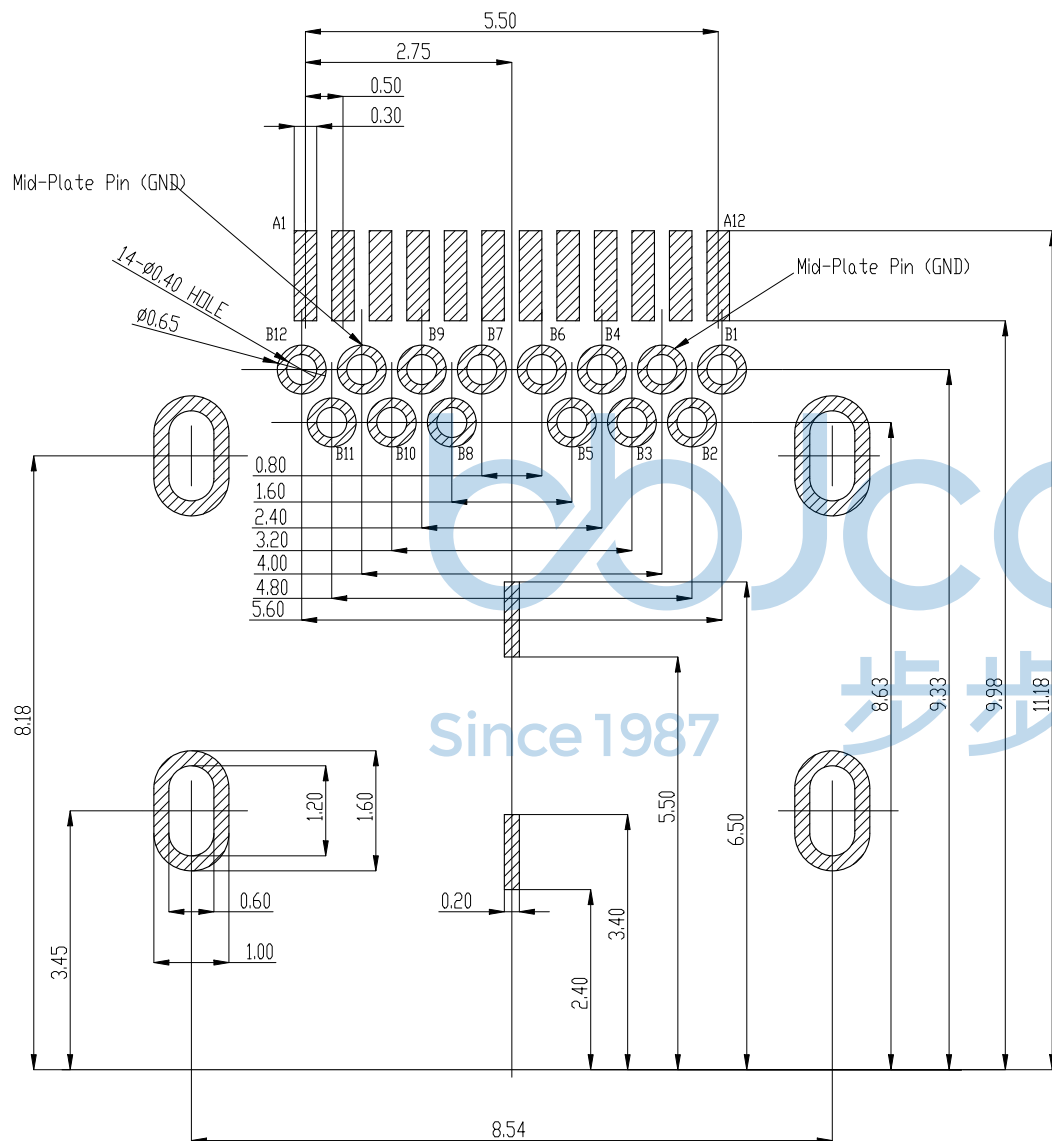


	PCB 1.0mm	PCB 1.6mm
DIM-A	1.50mm	1.90mm

THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co.,Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		深圳市步步精科技有限公司		NAME: TYPE-C 24P母座 板上四脚插SMT+DIP L=11.33 CH=1.58编带 端子镀金1U 脚长1.90	
.X: ±0.38 .XX: ±0.25 .XXX: ±0.13		X': ±3' .X': ±2' .XX': ±1'		PJ. NO.: UC.01.52-1W-0036 SIZE: A4 DRW NO.:	
APPD. JM_Zheng		CHKD. LYX		FINISH: SEE NOTES MAT'L.: SEE NOTES	
PDWG.NO: 0366-2		DR. TSP		SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/4	



THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co., Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		深圳市步步精科技有限公司	
.X: ±0.38	X*: ±3*	NAME: TYPE-C 24P母座 板上四脚插SMT+DIP L=11.33 CH=1.58编带 端子镀金1U 脚长1.90	
.XX: ±0.25	.X*: ±2*		
.XXX: ±0.13	.XX*: ±1*		
APPD.	JM_Zheng	PJ. NO.: UC.01.52-1W-0036	
CHKD.	LYX	SIZE: A4 DRW NO.:	
PDWG.NO:	0366-2	FINISH: SEE NOTES MAT'L.: SEE NOTES	
DR.	TSP	SCALE: N/A REV.: A0 UNIT: mm PAGE: 2/4	



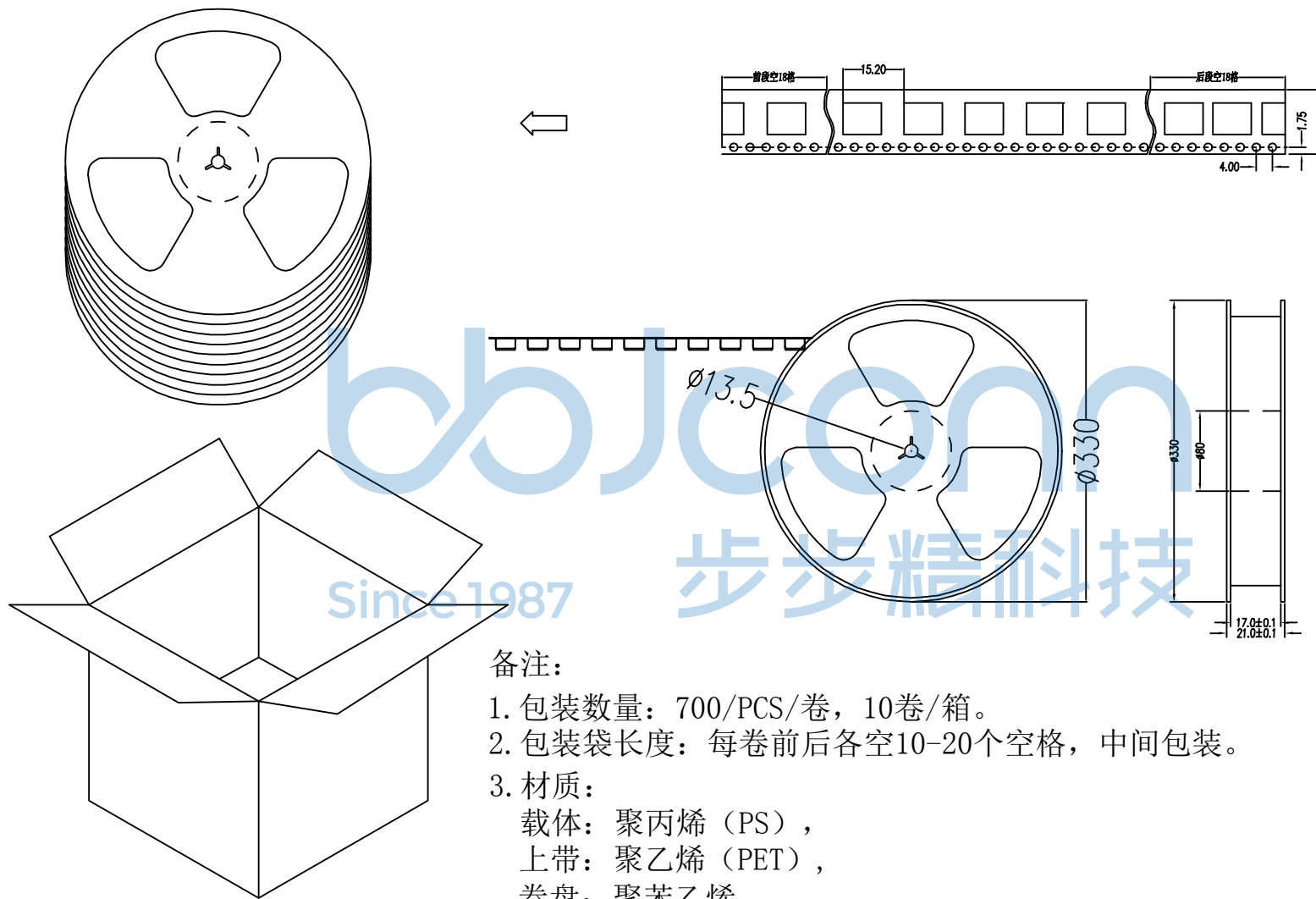
Recomanded PCB LAYOUT
TOLANCE ± 0.05
PCB Tinkness = 1.0 For 1.50 Solder tail
1.6 For 1.90 Solder tail

USB TYPE -C Pin Assignments

Pin Number	Signal Name	Pin Number	Signal Name
A1	GND	B12	GND
A2	SSTXp1	B11	SSRXp1
A3	SSTXn1	B10	SSRXn1
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	Dp1	B7	Dn2
A7	Dn1	B6	Dp2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A10	SSRXn2	B3	SSTXn2
A11	SSRXp2	B2	SSTXp2
A12	GND	B1	GND



THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co.,Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION. PDWG.NO: 0366-2		深圳市步步精科技有限公司			
		.X: ±0.38 .XX: ±0.25 .XXX: ±0.13		X': ±3" .X': ±2" .XX': ±1"	
	NAME: TYPE-C 24P母座 板上四脚插SMT+DIP L=11.33 CH=1.58编带 端子镀金1U 脚长1.90				
	APPD. JM_Zheng		PJ. NO.: UC.01.52-1W-0036		
	CHKD. LYX		SIZE: A4 DRW NO.:		
	FINISH: SEE NOTES		MAT'L.: SEE NOTES		
SCALE: N/A REV.: A0		UNIT: mm	PAGE: 3/4		



备注:

1. 包装数量: 700/PCS/卷, 10卷/箱。
2. 包装袋长度: 每卷前后各空10-20个空格, 中间包装。
3. 材质:
载体: 聚丙烯 (PS) ,
上带: 聚乙烯 (PET) ,
卷盘: 聚苯乙烯。

纸箱规格: 345*345*23MM

纸箱规格: 345*345*35MM

THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co.,Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		深圳市步步精科技有限公司	
.X: ±0.38 .XX: ±0.25 .XXX: ±0.13		X": ±3" .X": ±2" .XX": ±1"	
APPD.		JM_Zheng	
CHKD.		LYX	
PDWG,NO: 0366-2		DR. TSP	
NAME: TYPE-C 24P母座 板上四脚插SMT+DIP L=11.33 CH=1.58编带 端子镀金1U 脚长1.90		PJ. NO.: UC.01.52-1W-0036	
		SIZE: A4 DRW NO.:	
		FINISH: SEE NOTES MAT'L.: SEE NOTES	
		SCALE: N/A REV.: A0 UNIT: mm PAGE: 4/4	